



<b>Form Type</b>	Distribute	<b>Version</b>	2.0	<b>Ref</b>	IPC 1752A	<b>Sectionals</b>	Material Info	<b>Subsectionals</b>	D, A
<b>Supplier Information</b>									
<b>Company Name</b>	TE Connectivity	<b>Request Document ID</b>		<b>Contact Name</b>	Benfer, David W	<b>Contact Title</b>	Prod Compliance Engineer for DND		
<b>Company Unique ID</b>	TE Connectivity	<b>Response Date</b>	2017-07-03	<b>Contact Email</b>	dave.benfer@te.com				
<b>Contact Phone Number</b>	717-986-3725								
<b>Legal Statement</b>									
<b>Supplier Acceptance</b>	true								
<b>Legal Statement</b>									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
<b>Product</b>									
<b>Manufacturer Item number</b>	292207-8	<b>Amount</b>	415.981816	<b>Version</b>	-	<b>Identity</b>			
<b>Manufacturer Item Name</b>	MINI CT SGL DIP V 8P NAT	<b>Weight Uom</b>	mg	<b>Mfr Site</b>		<b>Authority</b>			
<b>Date</b>		<b>UOM</b>	Each						
<b>EUroHS-0508</b>	Product(s) meets EU RoHS requirement without any exemptions								
<b>ChinaRoHS-0508</b>	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
<b>EUREACH-0616</b>	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
<b>Complex Article Description</b>	REACH Candidate Substances of Very High Concern according to Once an Article Always an Article are Not Yet Reviewed								
<b>Product Disclosure</b>									
<b>Sub-Item/Material/Substance</b>	<b>Level</b>	<b>Name</b>	<b>Substance Category</b>	<b>Substance CAS</b>	<b>Substance Concentration</b>	<b>Quantity</b>	<b>Mass per Unit</b>	<b>UOM</b>	<b>Exemption</b>
Sub-Item	1	0.5SQ POST				4.0	18.747	mg	
Material	2	Nickel Plate				4.0	0.22	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	4.0	4.4E-4	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	4.0	2.2E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	4.0	0.21934	mg	
Material	2	Tin Plate				4.0	0.225	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	4.0	4.5E-4	mg	
Substance	3	Tin	Supplier	7440-31-5	99.73	4.0	0.22439	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	4.0	1.575E-4	mg	
Material	2	Brass				4.0	18.302	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	4.0	9.151E-5	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.2	4.0	0.036604	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	4.0	0.0018302	mg	
Substance	3	Copper	Supplier	7440-50-8	68.5	4.0	12.53687	mg	
Substance	3	Zinc	Supplier	7440-66-6	31.0026	4.0	5.6741	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	4.0	0.018302	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	4.0	1.8302E-4	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.0099	4.0	0.0018119	mg	
Substance	3	Iron	Supplier	7439-89-6	0.07	4.0	0.0128114	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.0010	4.0	1.8302E-4	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.05	4.0	0.009151	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	4.0	9.151E-4	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	4.0	0.009151	mg	
Sub-Item	1	AMP 1.5 MINI CT CONN				1.0	276.0	mg	
Material	2	PA66-GF20-FR				1.0	276.0	mg	

Substance	3	Phenol, 2,4(or 2,6)-dibromo-, homopolymer	Brominated Flame Retardants (other than PBBs or PBDEs)	69882-11-7	20.0	1.0	55.2	mg	
Substance	3	Poly[imino(1,6-dioxo-1,6-hexanediyl)imino-1,6-hexanediyl]	Supplier	32131-17-2	52.0	1.0	143.52	mg	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	20.0	1.0	55.2	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	1.0	1.0	2.76	mg	
Substance	3	Antimony oxide (Sb2O3)	Supplier	1309-64-4	7.0	1.0	19.32	mg	
Sub-Item	1	0.5SQ POST				4.0	16.248454	mg	
Material	2	Nickel Plate				4.0	0.190703	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	4.0	3.8141E-4	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	4.0	1.907E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	4.0	0.19013	mg	
Material	2	Tin Plate				4.0	0.195304	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	4.0	3.9061E-4	mg	
Substance	3	Tin	Supplier	7440-31-5	99.73	4.0	0.19478	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	4.0	1.3671E-4	mg	
Material	2	Brass				4.0	15.862447	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	4.0	7.931223E-5	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.2	4.0	0.03172489	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	4.0	0.00158625	mg	
Substance	3	Copper	Supplier	7440-50-8	68.5	4.0	10.86578	mg	
Substance	3	Zinc	Supplier	7440-66-6	31.0026	4.0	4.91777	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	4.0	0.01586245	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	4.0	1.5862E-4	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.0099	4.0	0.00157038	mg	
Substance	3	Iron	Supplier	7439-89-6	0.07	4.0	0.01110371	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.0010	4.0	1.5862E-4	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.05	4.0	0.00793122	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	4.0	7.9312E-4	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	4.0	0.00793122	mg	